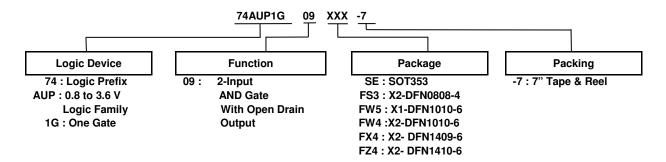


Ordering Information



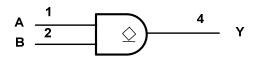
Device	Package	Package	Package	7" Tape	and Reel
Device	Code	(Notes 4 & 5)	Size	Quantity	Part Number Suffix
74AUP1G09SE-7	SE	SOT353	2.0mm x 2.0mm x 1.1mm 0.65 mm lead pitch	3,000/Tape & Reel	-7
74AUP1G09FS3-7	FS3	X2-DFN0808-4	0.8mm x 0.8mm x 0.35mm 0.5 mm pad pitch (diamond)	5,000/Tape & Reel	-7
74AUP1G09FW5-7	FW5	X1-DFN1010-6	1.0mm x 1.0mm x 0.5mm 0.35 mm pad pitch	5,000/Tape & Reel	-7
74AUP1G09FW4-7	FW4	X2-DFN1010-6	1.0mm x 1.0mm x 0.4mm 0.35 mm pad pitch	5,000/Tape & Reel	-7
74AUP1G09FX4-7	FX4	X2-DFN1409-6 Chip Scale Alternative	1.4mm x 0.9mm x 0.4mm 0.5 mm pad pitch	5,000/Tape & Reel	-7
74AUP1G09FZ4-7	FZ4	X2-DFN1410-6	1.4mm x 1.0mm x 0.4mm 0.5 mm pad pitch	5,000/Tape & Reel	-7

Notes: 4. Pad layout as shown on Diodes Inc. suggested pad layout document AP02001, which can be found on our website at http://www.diodes.com/datasheets/ap02001.pdf.

Pin Descriptions

Pin Name	Function
Α	Data Input
В	Data Input
GND	Ground
Υ	Data Output
V _{CC}	Supply Voltage

Logic Diagram



Function Table

Inpu	ıts	Output			
Α	A B				
L	L	L			
L	Н	L			
Н	L	L			
Н	Н	Z			

^{5.} The taping orientation is located on our website at http://www.diodes.com/datasheets/ap02007.pdf.



Absolute Maximum Ratings (Notes 6 & 7) (@T_A = +25 °C, unless otherwise specified.)

Symbol	Parameter	Rating	Unit
ESD HBM	Human Body Model ESD Protection	2	kV
ESD CDM	Charged Device Model ESD Protection	1	kV
V _{CC}	Supply Voltage Range	-0.5 to +4.6	V
VI	Input Voltage Range	-0.5 to +4.6	V
Vo	Voltage applied to output in High or Low State	-0.5 to +4.6	V
I _{IK}	Input Clamp Current V _I < 0	50	mA
I _{OK}	Output Clamp Current (V _O < 0)	50	mA
lo	Continuous Output Current (V _O = 0 to V _{CC})	±20	mA
Icc	Continuous Current Through V _{CC}	50	mA
I _{GND}	Continuous Current Through GND	-50	mA
TJ	Operating Junction Temperature	-40 to +150	℃
T _{STG}	Storage Temperature	-65 to +150	∞

Notes:

Recommended Operating Conditions (Note 8) (@T_A = +25 ℃, unless otherwise specified.)

Symbol	Par	rameter	Min	Max	Unit
Vcc	Operating Voltage		0.8	3.6	V
VI	Input Voltage		0	3.6	V
Vo	Output Voltage		0	3.6	V
		$V_{CC} = 0.8V$	_	20	μΑ
	Low-Level Output Current	V _{CC} = 1.1V	_	1.1	
ı		$V_{CC} = 1.4V$	_	1.7	
l _{OL}		V _{CC} = 1.65V	_	1.9	mA
		$V_{CC} = 2.3V$	_	3.1	
		$V_{CC} = 3.0V$	_	4	
Δt/ΔV	Input Transition Rise or Fall Rate	$V_{CC} = 0.8V \text{ to } 3.6V$	_	200	ns/V
T _A	Operating Free-Air Temperature		-40	125	.c

Note:

8. Unused inputs should be held at V_{CC} or Ground.

^{6.} Stresses beyond the absolute maximum may result in immediate failure or reduced reliability. These are stress values and device operation should be within recommend values.7. Forcing the maximum allowed voltage could cause a condition exceeding the maximum current or conversely forcing the maximum current could cause a condition exceeding the maximum voltage. The ratings of both current and voltage must be maintained within the controlled range.



Electrical Characteristics (@T_A = +25 °C, unless otherwise specified.)

Cumahad	Davamatav	Took Conditions	.,	T _A =	+25℃	T _A = -40 °	C to +85°C	l lmia	
Symbol	Parameter	Test Conditions	Vcc	Min	Max	Min	Max	Unit	
		_	0.8V to 1.65V	0.80 x V _{CC}	_	0.80 x V _{CC}	_		
M	High-Level	_	1.65V to 1.95V	0.65 x V _{CC}	_	0.65 x V _{CC}	_	V	
V _{IH}	Input Voltage	_	2.3V to 2.7V	1.6	_	1.6	_	v	
		_	3.0V to 3.6V	2.0	_	2.0	_		
		_	0.8V to 1.65V	_	0.30 x V _{CC}	_	0.30 x V _{CC}		
W	Low-Level	_	1.65V to 1.95V	_	0.35 x V _{CC}	_	0.35 x V _{CC}	V	
V_{IL}	Input voltage	_	2.3V to 2.7V	_	0.7		0.7	v	
		_	3.0V to 3.6V	_	0.9	_	0.9		
		$I_{OL} = 20\mu A$	0.8V to 3.6V	_	0.1	_	0.1		
		I _{OL} = 1.1mA	1.1V	_	0.3 x V _{CC}	_	0.3 x V _{CC}		
		I _{OL} = 1.7mA	1.4V	_	0.31	_	0.37		
	V _{OL} Low-Level Output Voltage	I _{OL} = 1.9mA	1.65V	_	0.31	_	0.35	.,	
V _{OL}		I _{OL} = 2.3mA		_	0.31		0.33	V	
		I _{OL} = 3.1mA	2.3V	_	0.44	_	0.45		
		I _{OL} = 2.7mA		_	0.31	_	0.33		
		I _{OL} = 4mA	3V	_	0.44	_	0.45		
l _l	Input Current	A or B Input V _I = GND to 3.6V	0V to 3.6V	_	± 0.1	_	± 0.5	μA	
loff	Power Down Leakage Current	V_1 or $V_0 = 0V$ to 3.6V	0	_	± 0.2	_	± 0.5	μΑ	
l _{OZ}	Z State Leakage Current	V _O = 3.6V V _i = 3.6V	3.6V	_	± 0.2	_	± 0.5	μΑ	
Δl _{OFF}	Delta Power Down Leakage Current	V _I or V _O = 0V to 3.6V	0V to 0.2V	_	0.2	-	0.6	μA	
Icc	Supply Current	$V_I = GND \text{ or } V_{CC}$ $I_O = 0$	0.8V to 3.6V	_	0.5	_	0.9	μA	
ΔI _{CC}	Additional Supply Current	Input at V _{CC} -0.6V	3.3V	_	40	_	50	μΑ	



Electrical Characteristics (continued) (@T_A = +25 °C, unless otherwise specified.)

Complete	Parameter	Test Conditions	V	T _A = -40 ℃	to +125°C	l locia
Symbol	Parameter	lest Conditions	Vcc	Min	Max	Unit
		_	0.8V to 1.65V	0.80 x V _{CC}	_	
VIH	High-Level Input	_	1.65V to 1.95V	0.70 x V _{CC}	_	V
VIH	Voltage	_	2.3V to 2.7V	1.6	_	v
		_	3.0V to 3.6V	2.0	_	
		_	0.8V to 1.65V	_	0.25 x V _{CC}	
V_{IL}	Low-Level Input	_	1.65V to 1.95V	_	0.35 x V _{CC}	V
VIL	Voltage	_	2.3V to 2.7V	_	0.7	·
		_	3.0V to 3.6V	_	0.9	
		$I_{OL} = 20 \mu A$	0.8V to 3.6V	_	0.11	
		I _{OL} = 1.1 mA	1.1V	_	0.3 x V _{CC}	
		I _{OL} = 1.7 mA	1.4V	_	0.41	
.,	Low-Level Output	I _{OL} = 1.9 mA	1.65V	_	0.39	
V_{OL}	Voltage	I _{OL} = 2.3 mA	0.01/	_	0.36	V
		I _{OL} = 3.1 mA	2.3V	_	0.50	
		I _{OL} = 2.7 mA	0)/	_	0.36	
		I _{OL} = 4 mA	3V	_	0.50	
II	Input Current	A or B Input V _I = GND to 3.6V	0V to 3.6V	_	± 0.75	μΑ
l _{OFF}	Power Down Leakage Current	V_I or $V_O = 0V$ to 3.6V	0	_	± 3.5	μΑ
loz	Z State Leakage Current	V _O = 3.6V V _i = 3.6V	3.6V	_	± 1.5	μΑ
ΔI_{OFF}	Delta Power Down Leakage Current	V_I or $V_O = 0V$ to 3.6V	0V to 0.2V		± 2.5	μΑ
Icc	Supply Current	$V_I = GND \text{ or } V_{CC}, I_O = 0$	0.8V to 3.6V	_	3.0	μA
ΔI _{CC}	Additional Supply Current	Input at V _{CC} -0.6V	3.3V	_	75	μΑ



Switching Characteristics

C_L=5pF, See Figure 1

Parameter	From Input	TO OUTPUT	V _{CC}	T _A = +25 °C			T _A = -40 °C to +85 °C		T _A = -40 °C to +125 °C		Unit
Taranicici			V CC	Min	Тур	Max	Min	Max	Min	Max	Ollit
			V8.0		13.5	_	_	_	_		
		V	1.2V ± 0.1V	1.9	4.6	10.4	1.8	11.4	1.8	12.6	ns
	٨		1.5V ± 0.1V	1.5	3.3	6.5	1.4	7.4	1.4	8.2	
lpd	Α	T T	1.8V ± 0.15V	1.2	2.9	5.1	1.1	5.9	1.1	6.5	
			2.5V ± 0.2V	1.0	2.4	4.4	0.9	4.6	0.9	4.9	
			$3.3V \pm 0.3V$	0.9	2.3	4.0	0.8	4.5	0.8	4.9	

C_L=10pF, See Figure 1

Parameter	From	TO OUTPUT	V	-	T _A = +25 °C			T _A = -40 °C to +85 °C		T _A = -40 °C to +125 °C	
raiametei	Input		Vcc	Min	Тур	Max	Min	Max	Min	Max	Unit
			V8.0	_	16.3	_	_	_	_	_	
		Y	1.2V ± 0.1V	2.3	5.6	12.3	2.1	13.7	2.1	15.1	ns
	٨		1.5V ± 0.1V	1.8	4.1	7.6	1.7	8.8	1.7	9.7	
t _{pd}	Α		1.8V ± 0.15V	1.6	3.2	7.3	1.4	7.1	1.4	7.0	
			2.5V ± 0.2V	1.4	2.9	6.1	1.2	6.4	1.2	5.9	
			$3.3V \pm 0.3V$	1.3	2.9	5.7	1.1	5.4	1.1	5.9	

C_L=15pF, See Figure 1

Parameter	From	TO OUTPUT	V	-	Γ _A = +25°0	С	T _A = -40 °C to +85 °C		T _A = -40 ℃	to +125℃	Unit
Parameter	Input		V _{CC}	Min	Тур	Max	Min	Max	Min	Max	Ollit
			0.8V	_	19.0	_	_			_	
			1.2V ± 0.1V	2.6	7.6	14.2	2.4	15.8	2.4	17.4	- ns
	٨	Y	1.5V ± 0.1V	2.1	6.5	12.1	1.9	12.7	1.9	12.9	
t _{pd}	Α		1.8V ± 0.15V	1.9	5.5	9.6	1.7	10.1	1.7	10.3	
			2.5V ± 0.2V	1.6	4.6	8.1	1.5	9.1	1.5	9.3	
			$3.3V \pm 0.3V$	1.6	4.1	7.5	1.4	8.3	1.4	9.1	

C_L=30pF, See Figure 1

Parameter	From	TO OUTPUT	V	-	Γ _A = +25°	С	T _A = -40 °C to +85 °C		T _A = -40 °C to +125 °C		Unit
Parameter	Input		V _{CC}	Min	Тур	Max	Min	Max	Min	Max	Ollit
			V8.0	_	27	_	_	_	_	_	
		Y	1.2V ± 0.1V	3.6	9.5	19.5	3.2	21.8	3.2	24	ns
	٨		1.5V ± 0.1V	2.9	8.5	16.1	2.6	13.6	2.6	15	
t _{pd}	Α		1.8V ± 0.15V	2.6	7.7	15.2	2.3	13.3	2.3	14.6	
			2.5V ± 0.2V	2.4	7	13.1	2.1	13.3	2.1	13.5	
			$3.3V \pm 0.3V$	2.3	6.5	12.7	2.1	12.9	2.1	12.9	



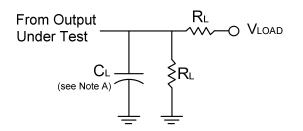
Operating and Package Characteristics (@T_A = +25 °C, unless otherwise specified.)

	Parameter	Test Condition	ons	Vcc	Тур	Unit
				0.8V	6.5	
				1.2V ± 0.1V	6.3	
_	Power Dissipation	f = 1MH	łz	1.5V ± 0.1V	6.3	"r
C_{pd}	Capacitance	No Loa	d	1.8V ± 0.15V	6.2	pF
				2.5V ± 0.2V	6.2	
				3.3V ± 0.3V	6.1	
Ci	Input Capacitance	V _i = V _{CC} or	GND	0V or 3.3V	1.5	pF
		SOT353		_	371	
		X2-DFN0808-4	(Nata O)	_	430	
0	Thermal Resistance	X1-DFN1010-6		_	435	°C/W
θ_{JA}	Junction-to-Ambient	X2-DFN1010-6	(Note 9)	_	445	-C/VV
		X2-DFN1409-6	1	_	470	
		X2-DFN1410-6	1	_	460	
		SOT353		_	143	
		X2-DFN0808-4		_	240	
_	Thermal Resistance	X1-DFN1010-6	(Note O)	_	250	°C/W
θ_{JC}	Junction-to-Case	X2-DFN1010-6	(Note 9)	_	250	-0/00
		X2-DFN1409-6	1	_	275	
		X2-DFN1410-6	1	_	265	1

Note: 9. Test condition for each of the six package types: Device mounted on FR-4 substrate PC board, 2oz copper, with minimum recommended pad layout.

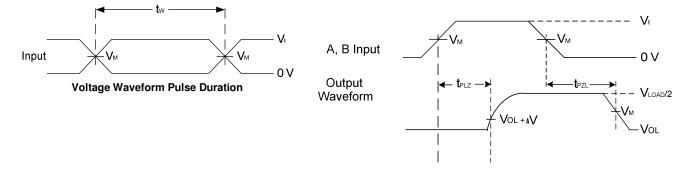


Parameter Measurement Information



TEST	Condition
t_{PLZ} (see Notes D and E) t_{PZL} (see Notes D and F)	Vload Vload

Vcc	In	puts	V _M	V _{LOAD}	CL	RL	VΔ
	V _I	t _r /t _f		LOAD			
0.8 V	V_{CC}	≤3ns	V _{CC} /2	2 X V _{CC}	5, 10, 15, 30 pF	5ΚΩ	0.1V
1.2 V±0.1 V	V_{CC}	≤3ns	V _{CC} /2	2 X V _{CC}	5, 10, 15, 30 pF	5ΚΩ	0.1V
1.5 V±0.1 V	V_{CC}	≤3ns	V _{CC} /2	2 X V _{CC}	5, 10, 15, 30 pF	5ΚΩ	0.15V
1.8 V±0.15 V	V_{CC}	≤3ns	V _{CC} /2	2 X V _{CC}	5, 10, 15, 30 pF	5ΚΩ	0.15V
2.5 V±0.2 V	V_{CC}	≤3ns	V _{CC} /2	2 X V _{CC}	5, 10, 15, 30 pF	5ΚΩ	0.15V
3.3 V±0.3 V	V_{CC}	≤3ns	V _{CC} /2	2 X V _{CC}	5, 10, 15, 30 pF	5ΚΩ	0.3V



Voltage Waveform Propagation Delay Times Inverting and Non Inverting Outputs

Figure 1 Load Circuit and Voltage Waveforms

Notes: A. Includes test lead and test apparatus capacitance.

- B. All pulses are supplied at pulse repetition rate \leq 10MHz.
- C. Inputs are measured separately one transition per measurement.
- D. t_{PLH} and t_{PHL} are the same as t_{PD}.



Marking Information

(1) SOT353

(Top View)

4 $\underline{XX}\ \underline{Y}\ \underline{W}\ \underline{X}$

2

3

XX: Identification code

Y: Year 0~9

<u>W</u>: Week: A~Z: 1~26 week;

a~z: 27~52 week; z represents

52 and 53 week \underline{X} : A $^{\sim}$ Z: Internal code

Part Number	Package	Identification Code
74ALIP1G09SE	SOT353	XB

(2) X2-DFN0808-4, X1-DFN1010-6, X2-DFN1010-6, X2-DFN1409-6 and X2-DFN1410-6

(Top View)

XX \underline{XX} : Identification Code \underline{Y} : Year: 0~9

 $\overline{\underline{W}}$: Week: A~Z: 1~26 week;

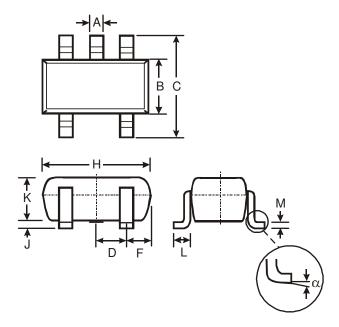
a~z: 27~52 week; z represents 52 and 53 week

X: A~Z: Internal code

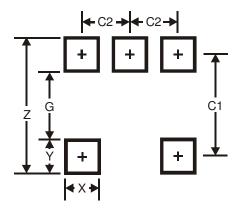
Part Number	Package	Identification Code
74AUP1G09FS3	X2-DFN0808-4	YU
74AUP1G09FW5	X1-DFN1010-6	Q8
74AUP1G09FW4	X2-DFN1010-6	XR
74AUP1G09FX4	X2-DFN1409-6	HG
74AUP1G09FZ4	X2-DFN1410-6	XR



SOT353 Package Outline Dimensions and Suggested Pad Layout



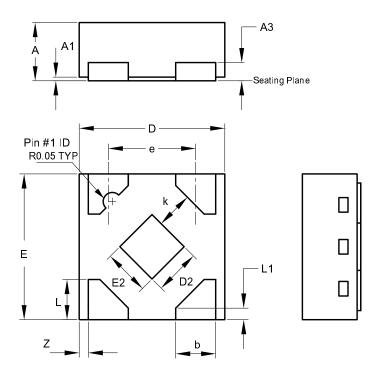
	SOT353				
Dim	Min	Max	Тур		
Α	0.10	0.30	0.25		
В	1.15	1.35	1.30		
С	2.00	2.20	2.10		
D	0.65 Typ				
F	0.40	0.45	0.425		
Н	1.80	2.20	2.15		
J	0	0.10	0.05		
K	0.90	1.00	1.00		
L	0.25	0.40	0.30		
М	0.10	0.22	0.11		
α	0°	8°	-		
All Dimensions in mm					



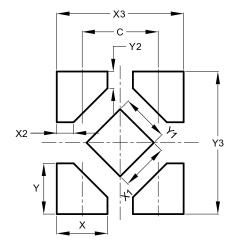
Dimensions	Value (in mm)
Z	2.5
G	1.3
Х	0.42
Υ	0.6
C1	1.9
C2	0.65



X2-DFN0808-4 Package Outline Dimensions and Suggested Pad Layout



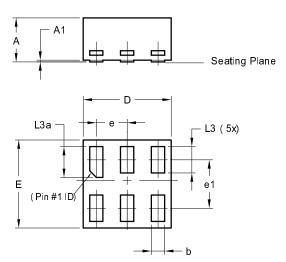
	X2-DFN0808-4				
Dim	Min	Max	Тур		
Α	0.25	0.35	0.30		
A1	0	0.04	0.02		
A3	-	1	0.13		
b	0.17	0.27	0.22		
D	0.75	0.85	0.80		
D2	0.15	0.35	0.25		
Е	0.75	0.85	0.80		
E2	0.15	0.35	0.25		
е	-	-	0.48		
K	0.20	-	-		
L	0.17	0.27	0.22		
L1	0.02	0.12	0.07		
Z	-	-	0.05		
All Dimensions in mm					



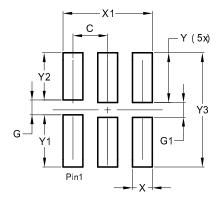
Dimensions	Value
С	0.480
X	0.320
X1	0.300
X2	0.106
Х3	0.800
Υ	0.320
Y1	0.300
Y2	0.106
Y3	0.900



X1-DFN1010-6 Package Outline Dimensions and Suggested Pad Layout



X1-DFN1010-6				
Dim	Min Max Typ			
Α	-	0.50	0.39	
A1	-	0.04	-	
b	0.12	0.20	0.15	
D	0.95	1.050	1.00	
Е	0.95	1.050	1.00	
е		0.35 BSC		
e1	0.55 BSC			
L3	0.27	0.30	0.30	
L3a	0.32	0.40	0.35	
All Dimensions in mm				

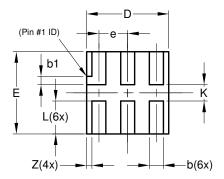


Dimensions	Value (in mm)
С	0.350
G	0.150
G1	0.150
Х	0.200
X1	0.900
Υ	0.500
Y 1	0.525
Y2	0.475
Y3	1.150

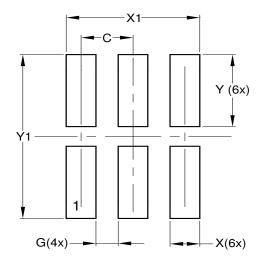


X2-DFN1010-6 Package Outline Dimensions and Suggested Pad Layout





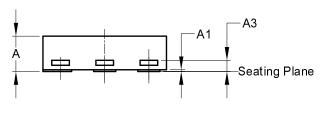
	X2-DFN1010-6				
Dim	Min	Max	Тур		
Α		0.40	0.39		
A1	0.00	0.05	0.02		
A3	_	_	0.13		
b	0.14	0.20	0.17		
b1	0.05	0.15	0.10		
D	0.95	1.05	1.00		
Е	0.95	1.05	1.00		
е	_	_	0.35		
L	0.35	0.45	0.40		
K	0.15		_		
Z			0.065		
All Dimensions in mm					

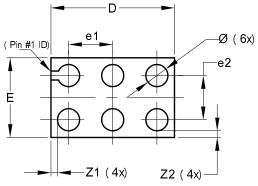


Dimensions	Value (in mm)
С	0.350
G	0.150
X	0.200
X1	0.900
Υ	0.550
Y1	1.250

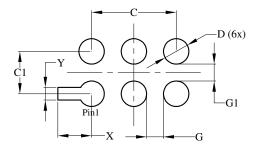


X2-DFN1409-6 Package Outline Dimensions and Suggested Pad Layout





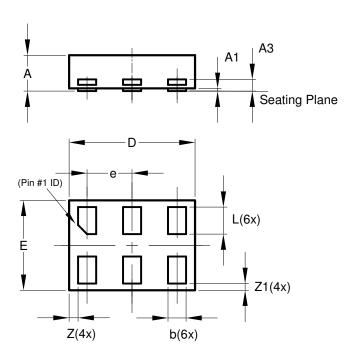
X2-DFN1409-6				
Dim	Min	Max	Тур	
Α	1	0.40	0.39	
A1	0	0.05	0.02	
A 3	-	-	0.13	
Ø	0.20	0.30	0.25	
D	1.35	1.45	1.40	
Е	0.85	0.95	0.90	
e1	-	-	0.50	
e2	1	-	0.50	
Z 1	-	-	0.075	
Z2	-	-	0.075	
All Dimensions in mm				



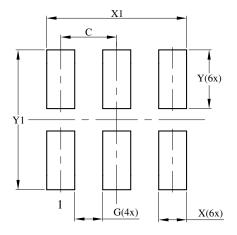
Dimensions	Value (in mm)	
С	1.000	
C1	0.500	
D	0.300	
G	0.200	
G1	0.200	
Х	0.400	
Υ	0.150	



X2-DFN1410-6 Package Outline Dimensions and Suggested Pad Layout



X2-DFN1410-6					
Dim	Min	Max	Тур		
Α	_	0.40	0.39		
A1	0.00	0.05	0.02		
A3	_	_	0.13		
b	0.15	0.25	0.20		
D	1.35	1.45	1.40		
Е	0.95	1.05	1.00		
е			0.50		
L	0.25	0.35	0.30		
Z			0.10		
Z 1	0.045	0.105	0.075		
All Dimensions in mm					



Dimensions	Value (in mm)	
С	0.500	
G	0.250	
Х	0.250	
X1	1.250	
Υ	0.525	
Y1	1.250	



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